OLI3539V.A1-940-A

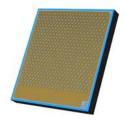
BIDOS® Core











Features:

— Chip Technology: GaAs VCSEL

- IR Laser Wavelength: 940 nm

- Optical Power Class: 3 W pulsed

— Radiation Profile: Multi-Mode

ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)

Ordering Information

Type	Operational Mode:	Ordering Code	
	$I_F = 4A, T_a = 25^{\circ}C$		
	$t_p = 100 \mu s, DC = 1\%$		
OLI3539V.A1-940-A	3.6 W	Q65113A1728	

Depending on the mode of operation, these devices emit highly concentrated visible and non-visible light which can be hazardous to the human eye. Products which incorporate these devices must follow the safety precautions given in the "Notes" section.



Maximum Ratings

 $T_a = 25$ °C

Parameter	Symbol		Values
Operation/Solder temperature	Ts	min.	-40 °C
$t_p = 100 \ \mu s; \ DC = 1 \ \%$		max.	110 °C
Storage temperature	T _{stg}	min.	-40 °C
		max.	110 °C
Forward current	lf	max.	10 A
Pulsed operation; T_p = 100 μ s; DC = 1%; T_S = 25°C			
Forward current	lf	max.	5 A
Direct current operation; DC = 100%; Ts = 25°C			
Reverse Voltage	Not designed for reverse operation		
ESD withstand voltage	VESD	max.	2 kV
acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)			

Note: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device.



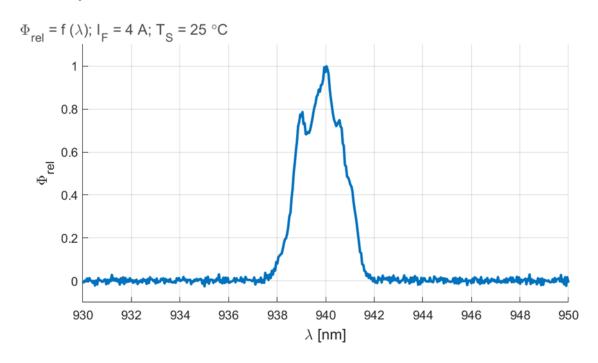
Characteristics

 $T_a = 25$ °C, $I_F = 4$ A; $t_p = 100 \ \mu s$; DC = 1%

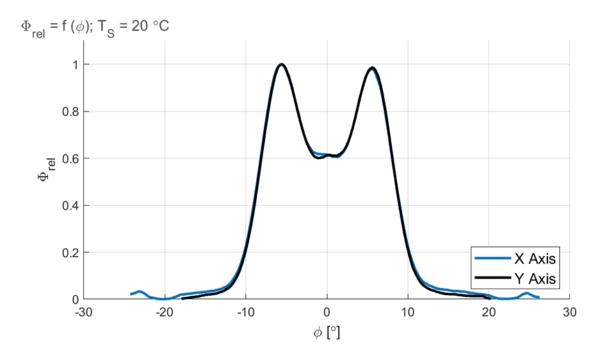
Parameter	Symbol		Values
Forward voltage	VF	typ.	2.3 V
Output power	Φ	typ.	3.6 W
Threshold current	I _{th}	typ.	0.5 A
Slope efficiency	SE	typ.	1.0 W / A
Power conversion efficiency	η	typ.	40 %
Peak wavelength	λpeak	min.	930 nm
		typ.	940 nm
		max.	950 nm
Spectral bandwidth at FWHC (50% of Φ_{max})	λFWHC	typ.	2 nm
Temperature coefficient of wavelength	ТСλ	typ.	0.066 nm /K
Field of view at FWHC (50% of Φ_{max})	φ _X	typ.	18°
	\$ Y	typ.	18°



Relative Spectral Emission 1)

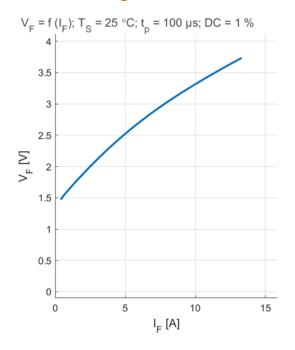


Radiation Characteristics 1)

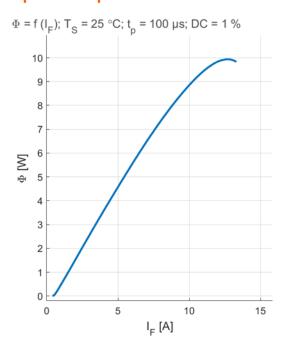




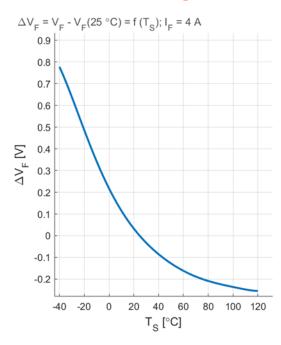
Forward Voltage 1) 2)



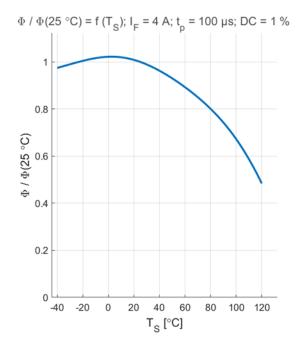
Optical Output Power 1) 2)



Relative Forward Voltage 1)

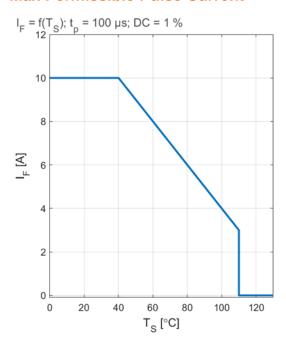


Relative Radiant Power 1)

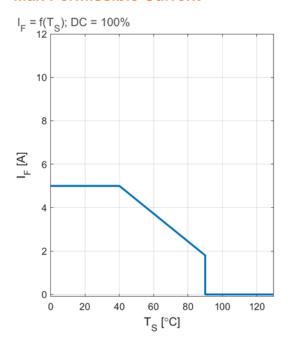




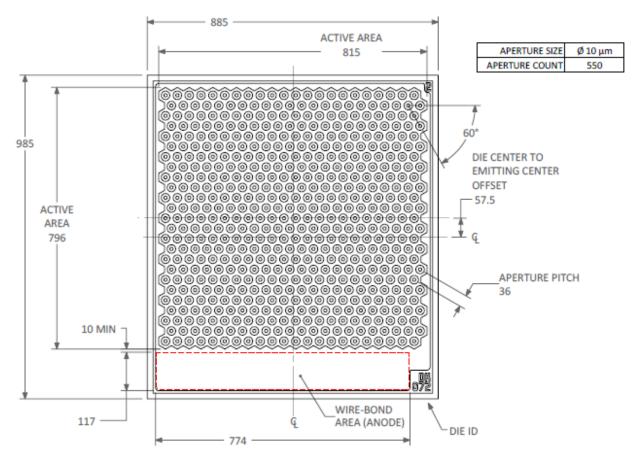
Max Permissible Pulse Current



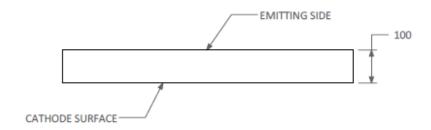
Max Permissible Current



Dimension Drawings 3)



DASHED LINES (WIRE-BOND AREA) ARE NOT VISIBLE ON ACTUAL DIE





Notes

Depending on the mode of operation, these devices emit highly concentrated visible and non-visible light which can be hazardous to the human eye. Products which incorporate these devices must follow the safety precautions given in IEC 60825-1.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes



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By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

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Glossary

- Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- Testing temperature: $T_a = 25$ °C
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.



Revision History

Version	Date	Change
0.0	November 9 th , 2020	Initiation of preliminary datasheet
1.0	February 25 th , 2021	Release

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